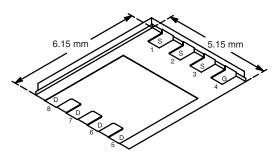


Vishay Siliconix

## N-Channel 25-V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	$R_{DS(on)}(\Omega)$ $I_D(A)^{a, g}$			
25	0.002 at $V_{GS} = 10 \text{ V}$	60	42 nC		
	$0.0025$ at $V_{GS} = 4.5 \text{ V}$	60	42 110		

#### PowerPAK® SO-8



**Bottom View** 

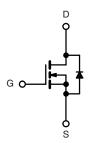
Ordering Information: Si7194DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

#### **FEATURES**

- Halogen-free
- TrenchFET® Power MOSFETs
- 100 % R<sub>g</sub> Tested
- 100 % Avalanche Tested

#### **APPLICATIONS**

- Low-Side in CPU and GPU core DC/DC
  - Gaming
  - Desktop



N-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	25	V	
Gate-Source Voltage		$V_{GS}$	± 20	V	
	T <sub>C</sub> = 25 °C		60 <sup>a, g</sup>		
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 70 °C	I_	60 <sup>a, g</sup>	7	
Continuous Diain Current (1 j = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	38 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		30 <sup>b, c</sup>	A	
Pulsed Drain Current		I <sub>DM</sub>	80		
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	I.	60 <sup>a, g</sup>		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	4.9 <sup>b, c</sup>	_	
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	50		
Single Pulse Avalanche Energy	L = 0.111111	E <sub>AS</sub>	125	mJ	
	T <sub>C</sub> = 25 °C		83		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	53	w	
	T <sub>A</sub> = 25 °C	' D	5.4 <sup>b, c</sup>	• • • • • • • • • • • • • • • • • • • •	
	T <sub>A</sub> = 70 °C		3.4 <sup>b, c</sup>		
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		
Soldering Recommendations (Peak Temperature		260			

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 10 s	R <sub>thJA</sub>	18	23	°C/W		
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	1.0	1.5	]		

- a. Based on  $T_C$  = 25 °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- d. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
  e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under Steady State conditions is 65 °C/W.
- g. Package Limited.

## **Si7194DP**

# Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static				1		
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V, I}_{D} = 250 \mu\text{A}$	25			٧
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$			23		mV/°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 5.7		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.0		2.6	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V	20		1	_
	I <sub>DSS</sub>	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			10	μΑ
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α
	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		0.0016	0.002	
Drain-Source On-State Resistance <sup>a</sup>		$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$		0.002	0.0025	Ω
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 20 A		120		S
Dynamic <sup>b</sup>					l	l
Input Capacitance	C <sub>iss</sub>			6590		
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		930		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			420		
·		V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		95	145	
Total Gate Charge	Charge $Q_g = Q_g = Q_g$	20 00 1		42	65	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$		16		
Gate-Drain Charge	Q <sub>gd</sub>			9.7		
Gate Resistance	$R_{g}$	f = 1 MHz	0.2	0.9	1.8	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			19	35	ns ns
Rise Time	t <sub>r</sub>	$V_{DD}$ = 10 V, $R_L$ = 1 $\Omega$		8	16	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong$ 10 A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$		47	90	
Fall Time	t <sub>f</sub>			9	18	
Turn-On Delay Time	t <sub>d(on)</sub>			46	85	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 10 V, $R_L$ = 1 $\Omega$		25	45	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		72	130	
Fall Time	t <sub>f</sub>	-		40	70	
<b>Drain-Source Body Diode Characteristi</b>	cs			<u> </u>		ı
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			60	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			80		А
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 4 A		0.73	1.1	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			41	80	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	1 40 A 45/44 400 A/22 T 05 20		43	90	nC
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		21		1
Reverse Recovery Rise Time	t <sub>b</sub>			20		ns

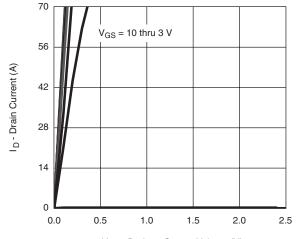
- a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



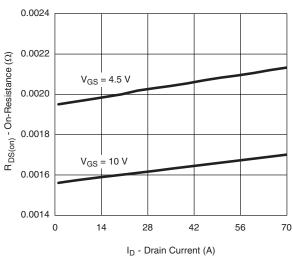
# Vishay Siliconix

## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

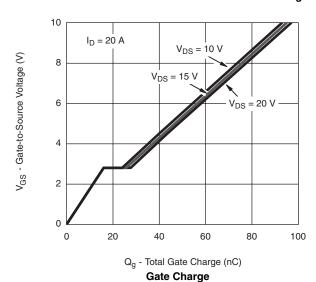


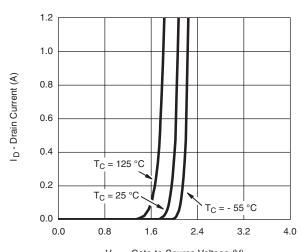
V<sub>DS</sub> - Drain-to-Source Voltage (V)

#### **Output Characteristics**



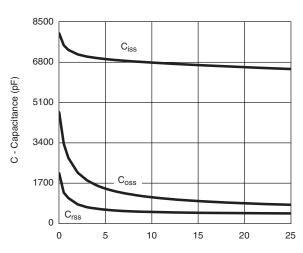
On-Resistance vs. Drain Current and Gate Voltage





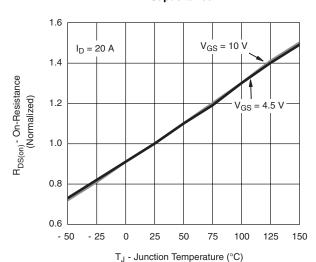
V<sub>GS</sub> - Gate-to-Source Voltage (V)

#### Transfer Characteristics



V<sub>DS</sub> - Drain-to-Source Voltage (V)

#### Capacitance

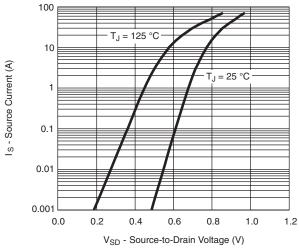


On-Resistance vs. Junction Temperature

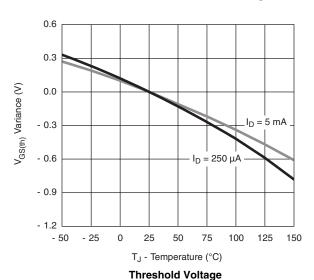
## **Si7194DP**

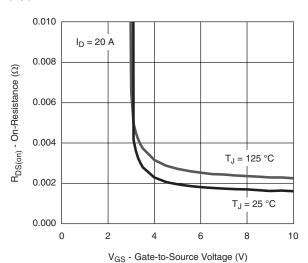
## Vishay Siliconix

## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

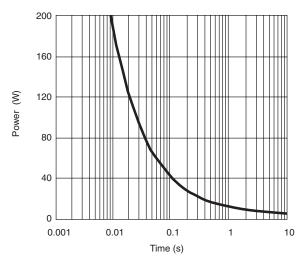


## Source-Drain Diode Forward Voltage

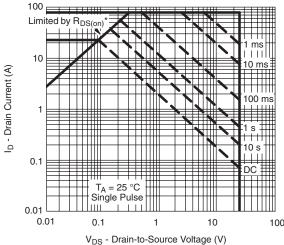




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



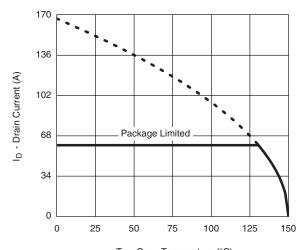
\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

Safe Operating Area, Junction-to-Ambient



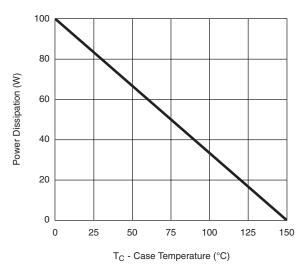
Vishay Siliconix

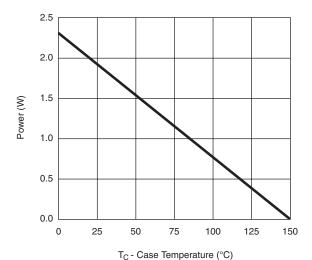
## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



T<sub>C</sub> - Case Temperature (°C)

## Current Derating\*





Power, Junction-to-Case

Power, Junction-to-Ambient

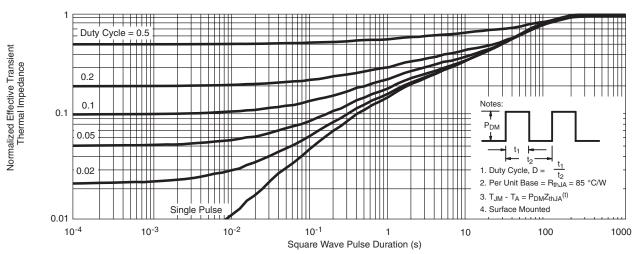
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 175$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

## **Si7194DP**

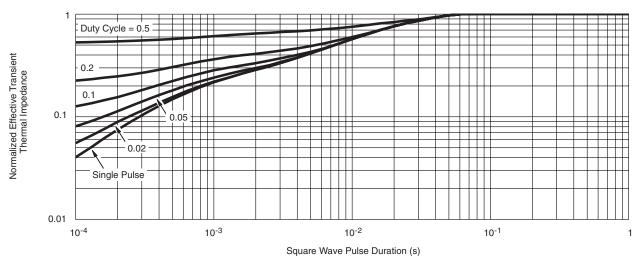
## Vishay Siliconix

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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



## Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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